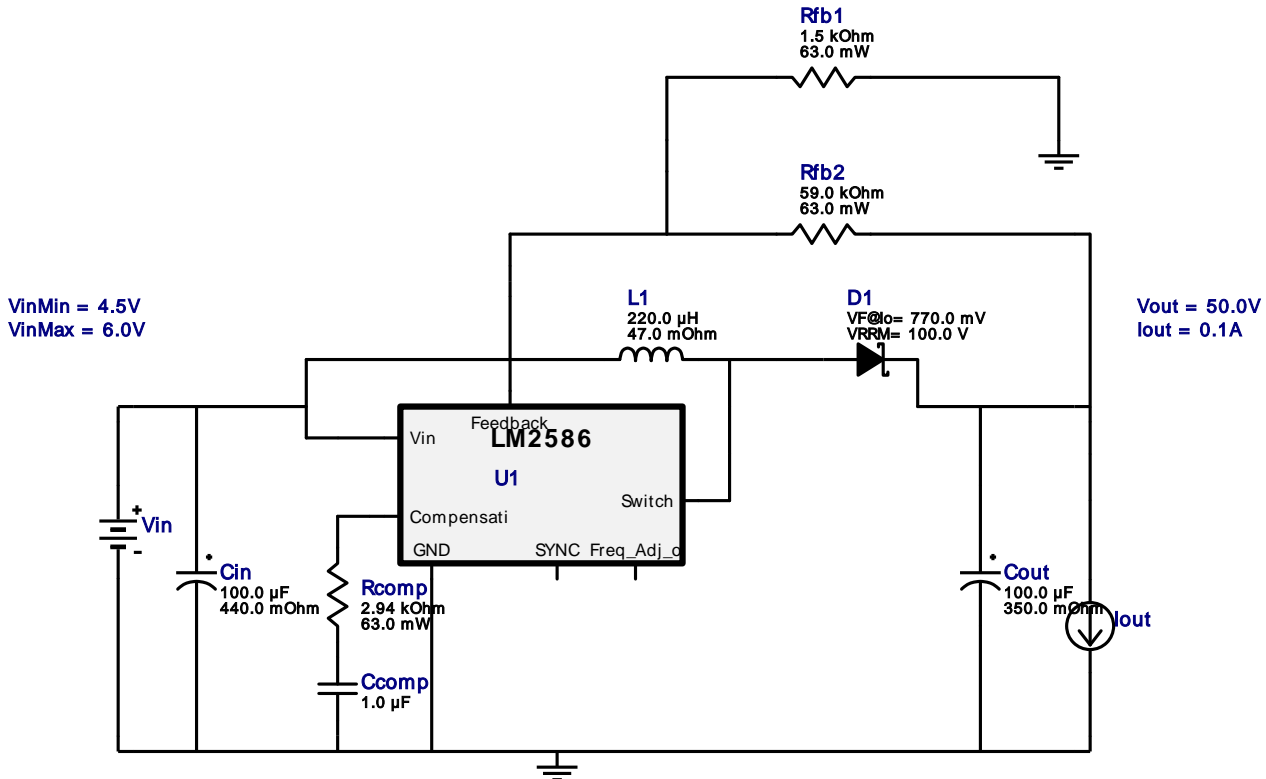


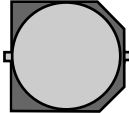



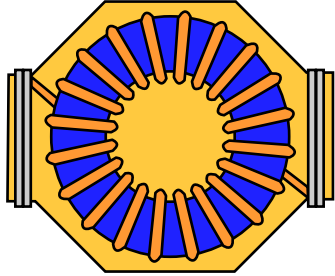



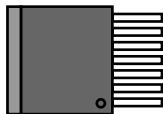
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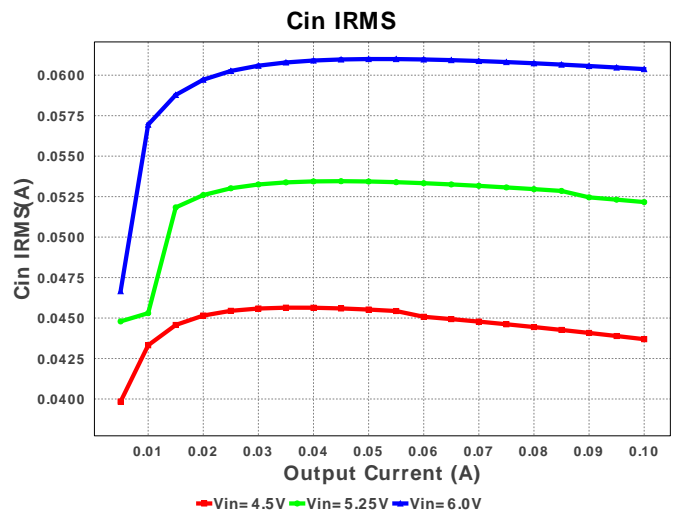
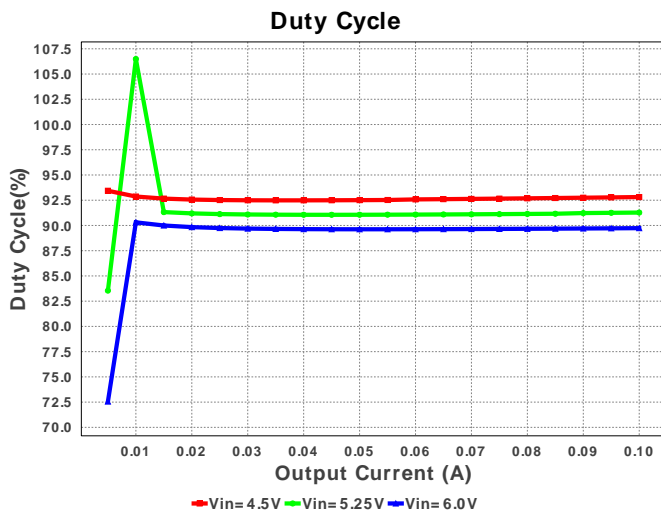
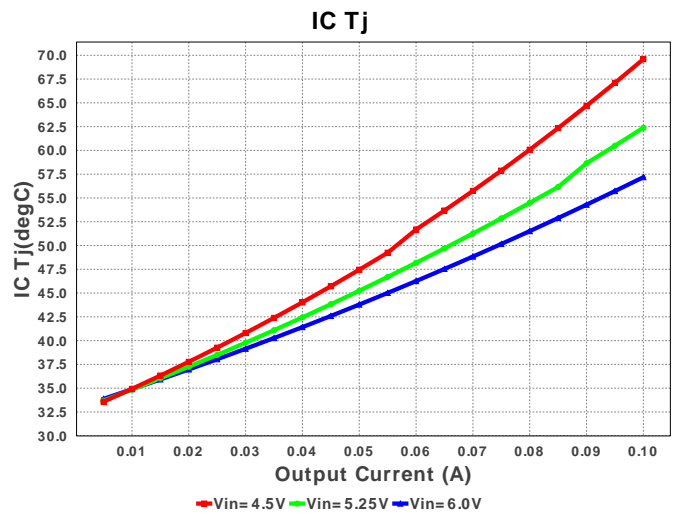
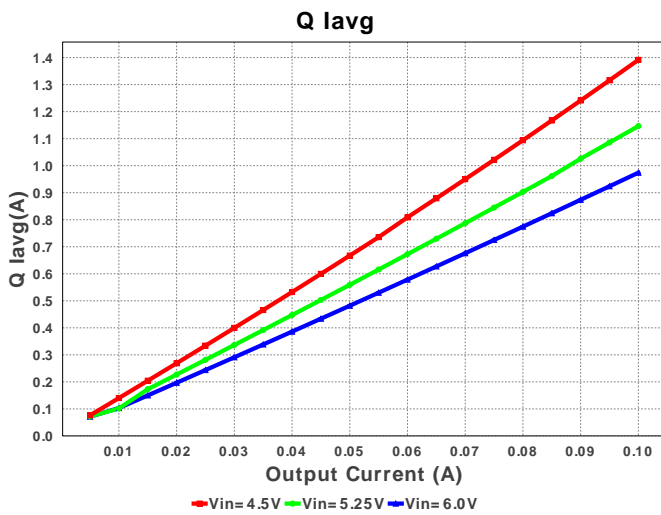
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 LM2586SX-ADJ/NOPB 4.5V-6.0V to 50.00V @ 0.1A

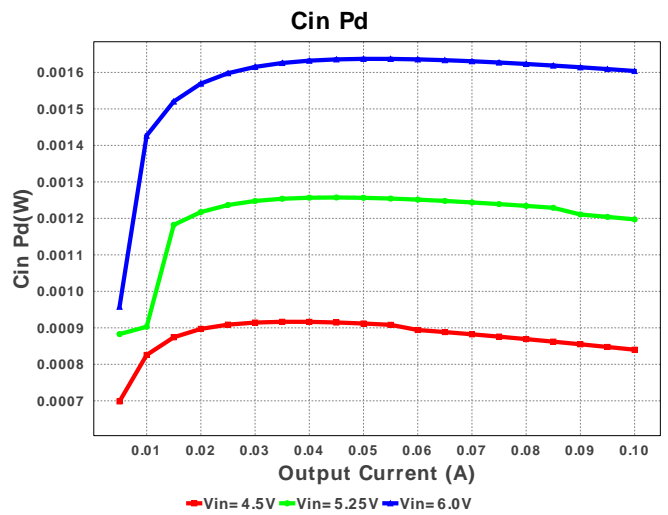
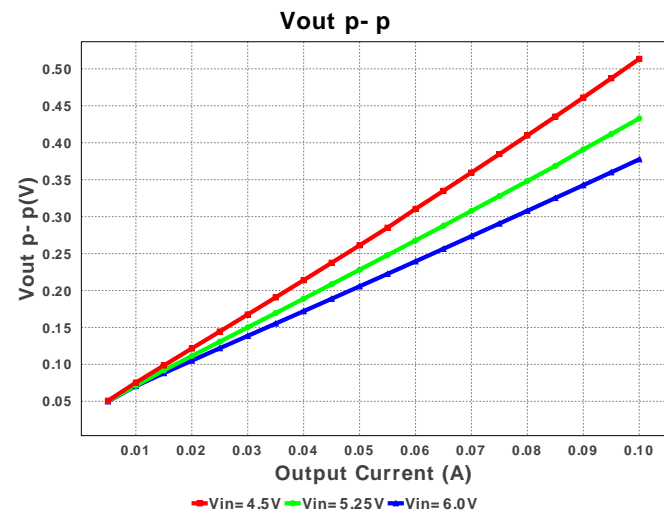
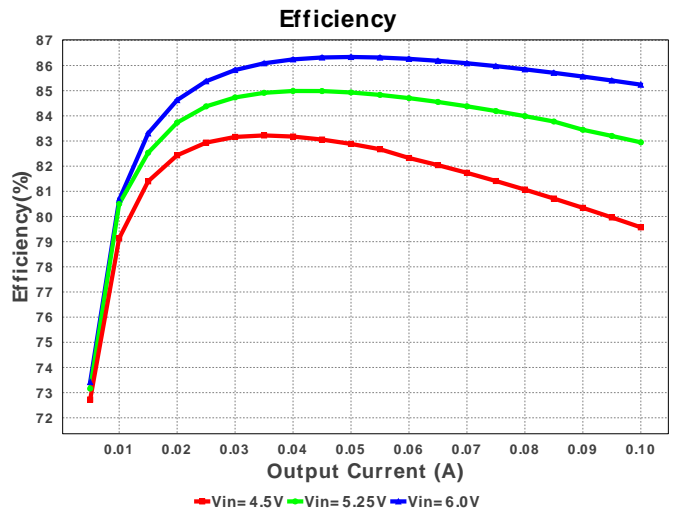
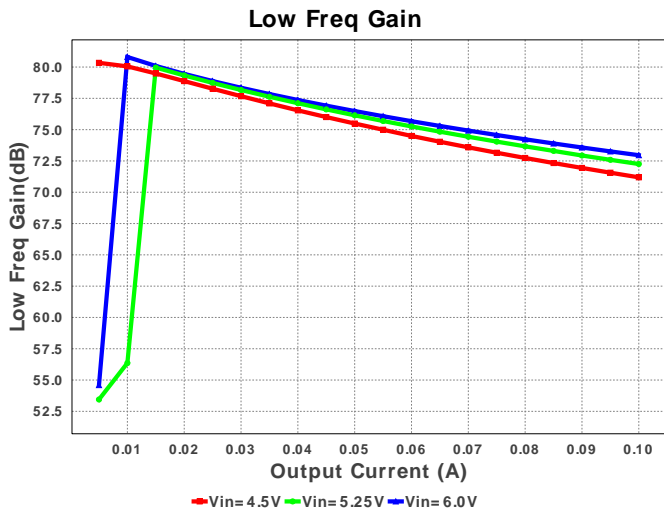
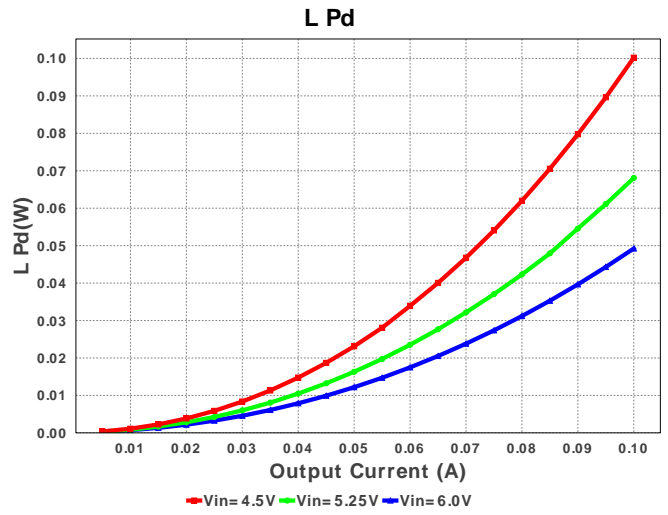
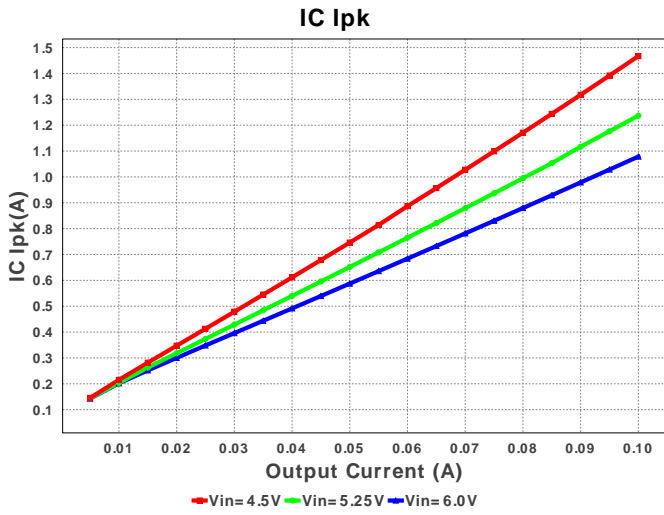


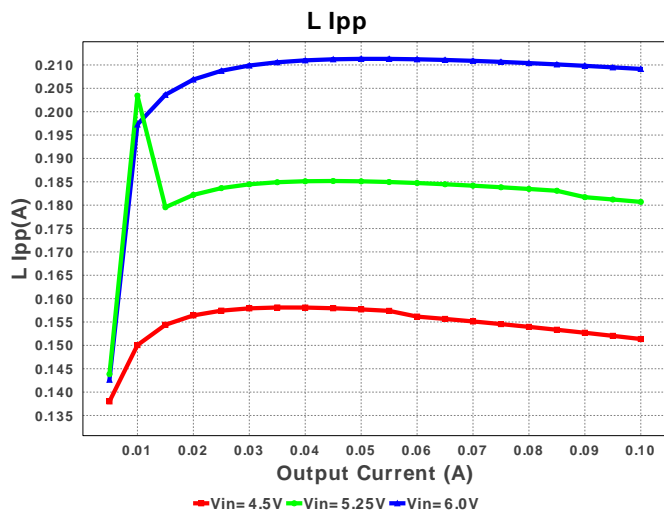
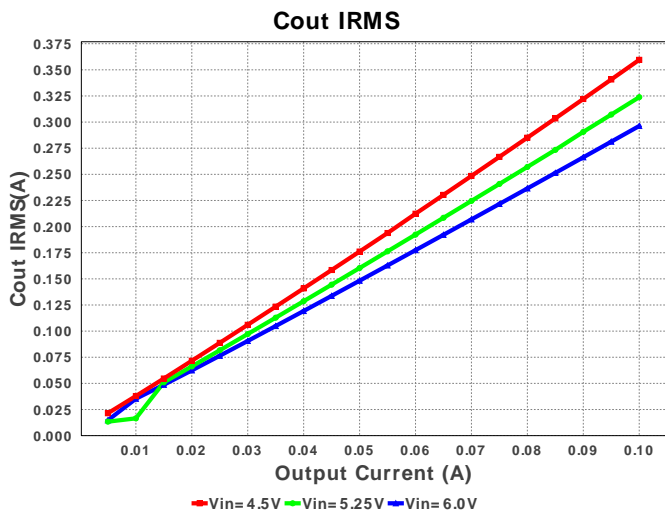
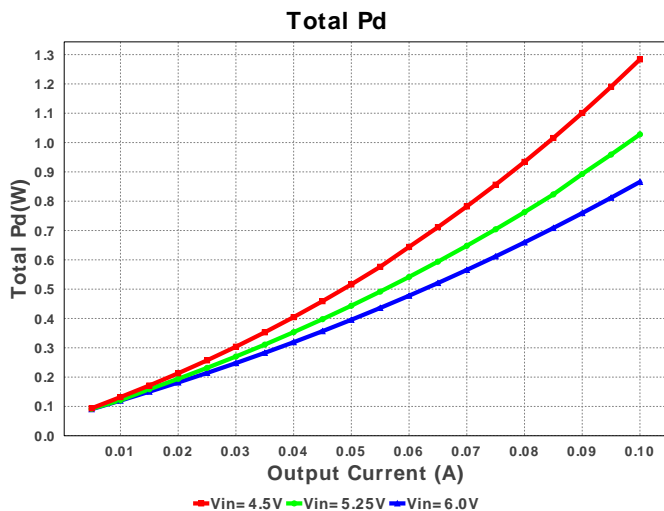
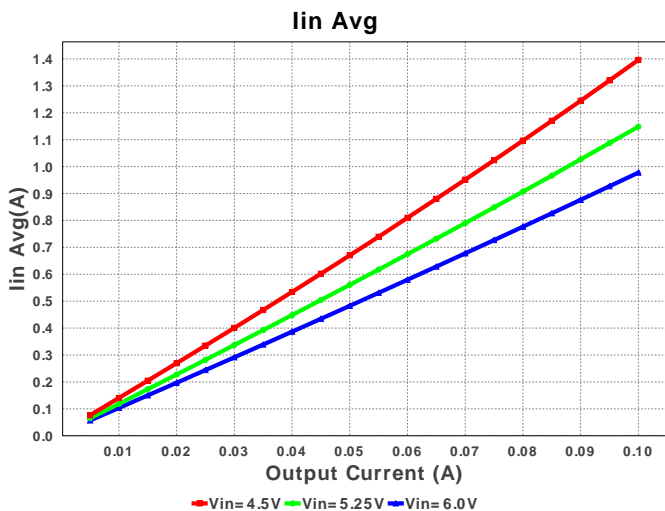
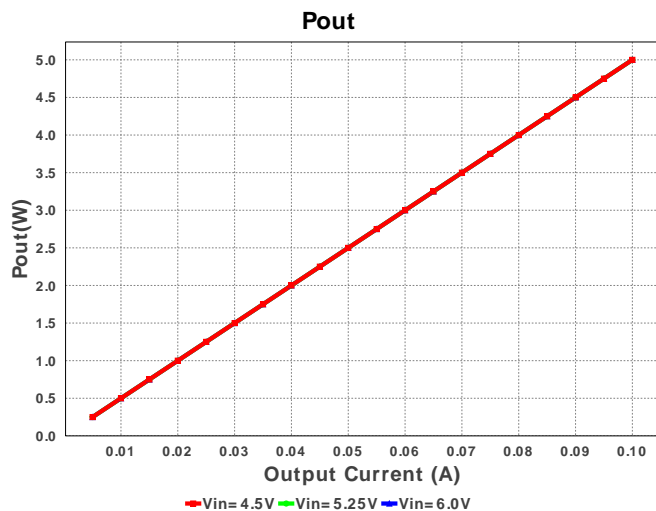
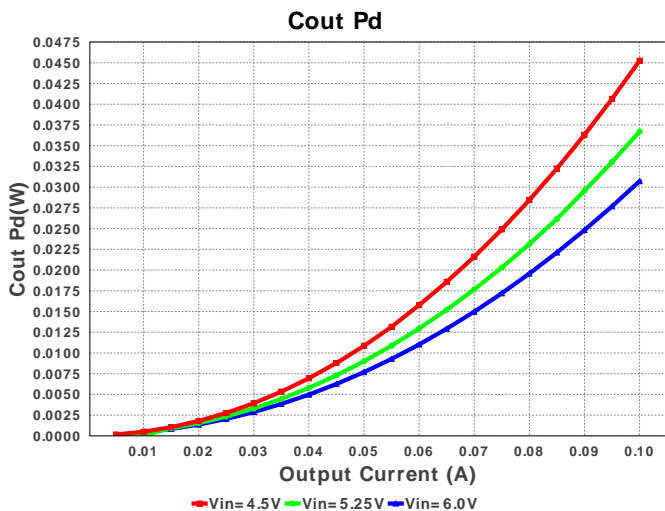
Electrical BOM

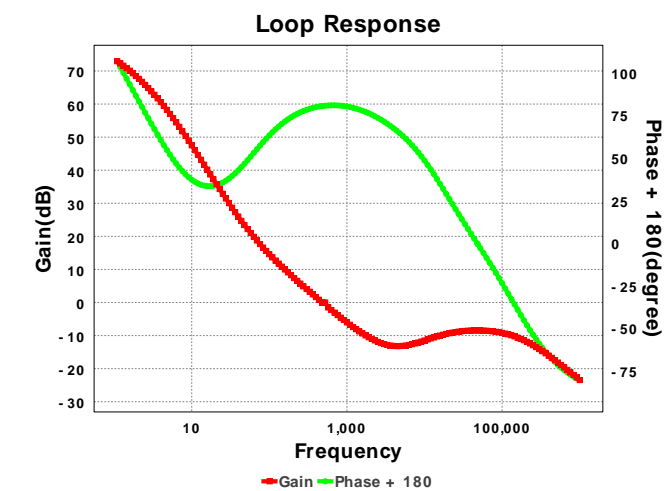
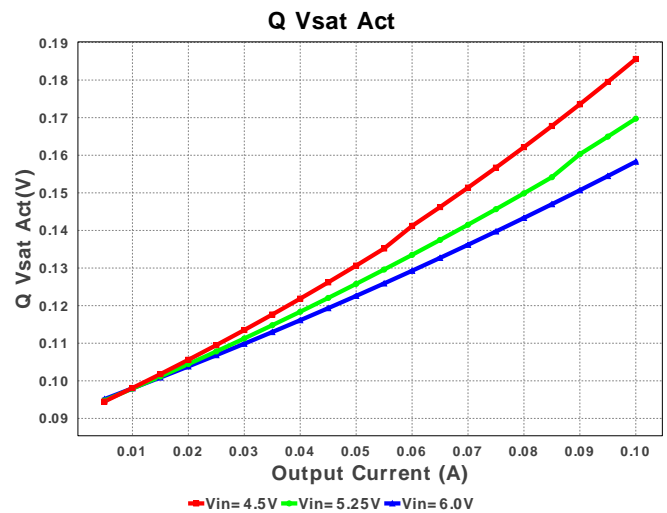
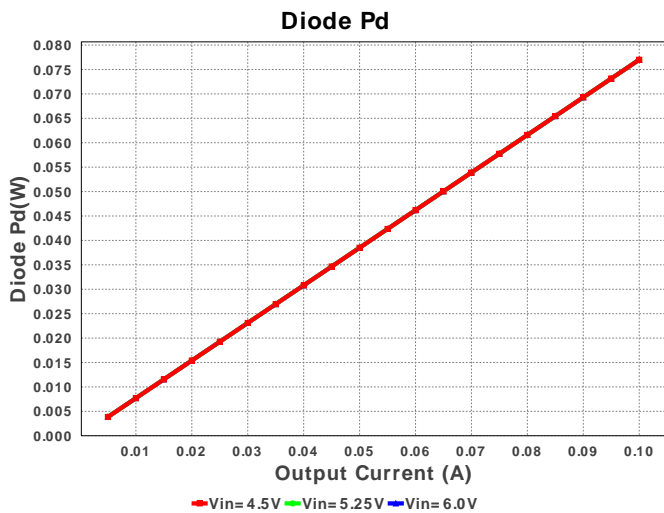
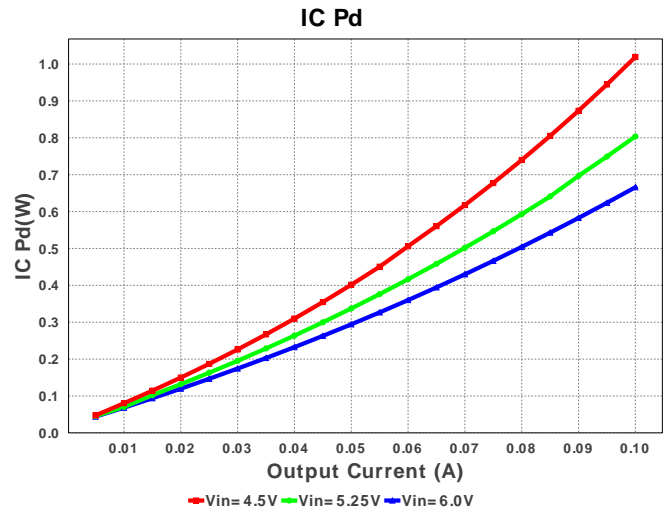
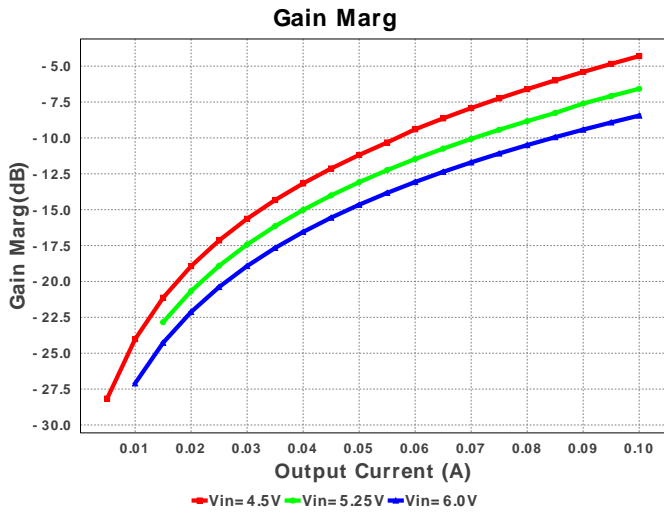
#	Name	Manufacturer	Part Number	Properties	Qty	Price	Footprint
1.	Ccomp	Taiyo Yuden	EMK212B7105KG-T Series= X7R	Cap= 1.0 uF VDC= 16.0 V IRMS= 0.0 A	1	\$0.02	 0805 7 mm ²
2.	Cin	Nichicon	UUD1A101MCL1GS Series= uD	Cap= 100.0 uF ESR= 440.0 mOhm VDC= 10.0 V IRMS= 230.0 mA	1	\$0.10	 SM_RADIAL_6.3AMM 80 mm ²
3.	Cout	Panasonic	EEE-FK1J101P Series= FK	Cap= 100.0 uF ESR= 350.0 mOhm VDC= 63.0 V IRMS= 400.0 mA	1	\$0.28	 SM_RADIAL_G 172 mm ²
4.	D1	Diodes Inc.	DFLS1100-7	VF@Io= 770.0 mV VRRM= 100.0 V	1	\$0.19	 PowerDI123 13 mm ²

#	Name	Manufacturer	Part Number	Properties	Qty	Price	Footprint
5.	L1	Bourns	PM2110-221K-RC	L= 220.0 μ H DCR= 47.0 mOhm	1	\$1.21	 PM2110 890 mm ²
6.	Rcomp	Vishay-Dale	CRCW04022K94FKED Series= CRCW..e3	Res= 2.94 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	 0402 3 mm ²
7.	Rfb1	Vishay-Dale	CRCW04021K50FKED Series= CRCW..e3	Res= 1.5 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	 0402 3 mm ²
8.	Rfb2	Vishay-Dale	CRCW040259K0FKED Series= CRCW..e3	Res= 59.0 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	 0402 3 mm ²
9.	U1	Texas Instruments	LM2586SX-ADJ/NOPB	Switcher	1	\$3.10	 TS7B 199 mm ²









Operating Values

#	Name	Value	Category	Description
1.	Cin IRMS	42.758 mA	Current	Input capacitor RMS ripple current
2.	Cout IRMS	363.768 mA	Current	Output capacitor RMS ripple current
3.	IC Ipk	1.496 A	Current	Peak switch current in IC
4.	Iin Avg	1.418 A	Current	Average input current
5.	L Ipp	148.12 mA	Current	Peak-to-peak inductor ripple current
6.	Q Iavg	1.422 A	Current	Q Iavg
7.	BOM Count	9	General	Total Design BOM count
8.	FootPrint	1.37 k mm ²	General	Total Foot Print Area of BOM components
9.	Frequency	100.0 kHz	General	Switching frequency
10.	IC Tolerance	0.0 V	General	IC Feedback Tolerance
11.	Pout	5.0 W	General	Total output power

#	Name	Value	Category	Description
12.	Q Vsat Act	233.513 mV	General	Q Vsat
13.	Total BOM	\$4.93	General	Total BOM Cost
14.	Cross Freq	334.675 Hz	Op_point	Bode plot crossover frequency
15.	Duty Cycle	92.968 %	Op_point	Duty cycle
16.	Efficiency	78.36 %	Op_point	Steady state efficiency
17.	Gain Marg	-3.831 dB	Op_point	Bode Plot Gain Margin
18.	IC Tj	91.369 degC	Op_point	IC junction temperature
19.	ICThetaJA	40.0 degC/W	Op_point	IC junction-to-ambient thermal resistance
20.	IOUT_OP	100.0 mA	Op_point	Iout operating point
21.	Phase Marg	73.976 deg	Op_point	Bode Plot Phase Margin
22.	VIN_OP	4.5 V	Op_point	Vin operating point
23.	Vout p-p	523.617 mV	Op_point	Peak-to-peak output ripple voltage
24.	Cin Pd	804.427 μ W	Power	Input capacitor power dissipation
25.	Cout Pd	46.315 mW	Power	Output capacitor power dissipation
26.	Diode Pd	77.0 mW	Power	Diode power dissipation
27.	IC Pd	1.111 W	Power	IC power dissipation
28.	L Pd	104.635 mW	Power	Inductor power dissipation
29.	Total Pd	1.381 W	Power	Total Power Dissipation
30.	Low Freq Gain	71.079 dB	Unknown	Gain at 10Hz

Design Inputs

#	Name	Value	Description
1.	Iout	100.0 m	Maximum Output Current
2.	Iout1	100.0 m	Output Current #1
3.	VinMax	6.0	Maximum input voltage
4.	VinMin	4.5	Minimum input voltage
5.	Vout	50.0	Output Voltage
6.	Vout1	50.0	Output Voltage #1
7.	base_pn	LM2586	Base Product Number
8.	source	DC	Input Source Type
9.	Ta	30.0	Ambient temperature

Design Assistance

1. **LM2586** Product Folder : <http://www.ti.com/product/LM2586> : contains the data sheet and other resources.

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